

## ABSTRACT

An electronic device wherein an electronic element is electrically connected to a substrate through an interposer and a method of manufacturing the same are disclosed. The electronic device comprises an electronic element and an interposer including an interposer base to which the electronic element is joined and plural post electrodes connected to corresponding electrodes of the electronic element. In the electronic device, the electronic element and the interposer base are integrated with each other by being brought into direct contact with each other, and the post electrodes are formed directly on the corresponding electrodes of the electronic element.